

TOSHIBA Diode Silicon Epitaxial Schottky Barrier Type

## DSF07S30U

High Speed Switching Application

Unit: mm

### Absolute Maximum Ratings (Ta = 25°C)

| Characteristic            | Symbol    | Rating     | Unit |
|---------------------------|-----------|------------|------|
| Reverse voltage           | $V_R$     | 30         | V    |
| Average forward current   | $I_O$     | 700 *      | mA   |
| Surge current (10ms)      | $I_{FSM}$ | 5          | A    |
| Junction temperature      | $T_j$     | 125        | °C   |
| Storage temperature range | $T_{stg}$ | -55 to 125 | °C   |

\*: Mounted on a glass-epoxy circuit board of 20 × 20 mm, pad dimensions of 4 × 4 mm.

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

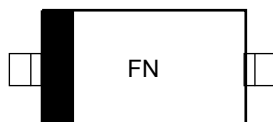
|         |        |
|---------|--------|
|         |        |
| JEDEC   | —      |
| JEITA   | —      |
| TOSHIBA | 1-1E1A |

Weight: 4.5 mg (typ.)

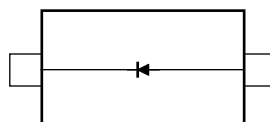
### Electrical Characteristics (Ta = 25°C)

| Characteristic    | Symbol     | Test Circuit | Test Condition              | Min | Typ. | Max  | Unit |
|-------------------|------------|--------------|-----------------------------|-----|------|------|------|
| Forward voltage   | $V_F$ (1)  | —            | $I_F = 10\text{mA}$         | —   | 0.20 | —    | V    |
|                   | $V_F$ (2)  | —            | $I_F = 200\text{mA}$        | —   | 0.30 | —    |      |
|                   | $V_F$ (3)  | —            | $I_F = 700\text{mA}$        | —   | 0.39 | 0.45 |      |
| Reverse current   | $I_{R(1)}$ | —            | $V_R = 30\text{V}$          | —   | 12   | 50   | μA   |
| Total capacitance | $C_T$      | —            | $V_R = 0, f = 1\text{ MHz}$ | —   | 170  | —    | pF   |

### Marking

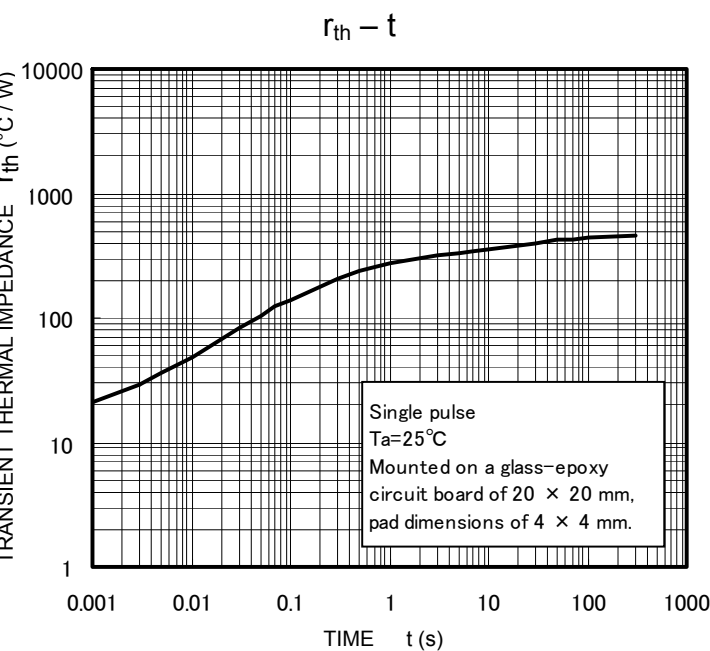
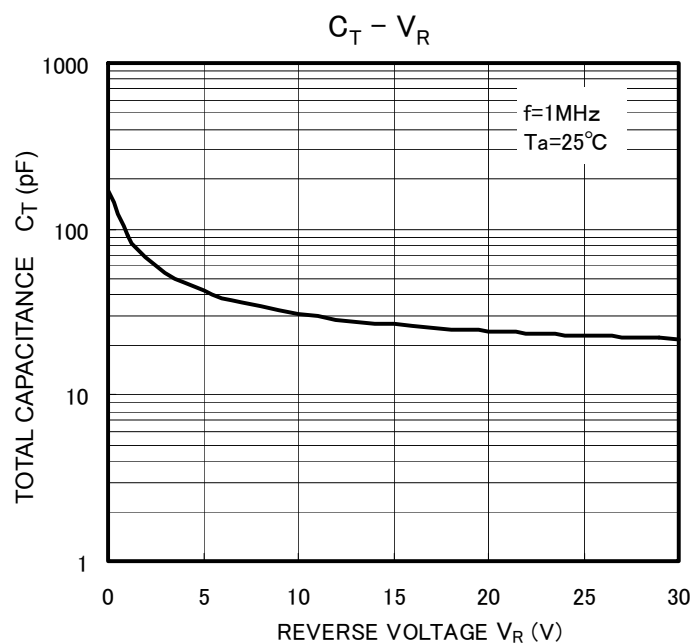
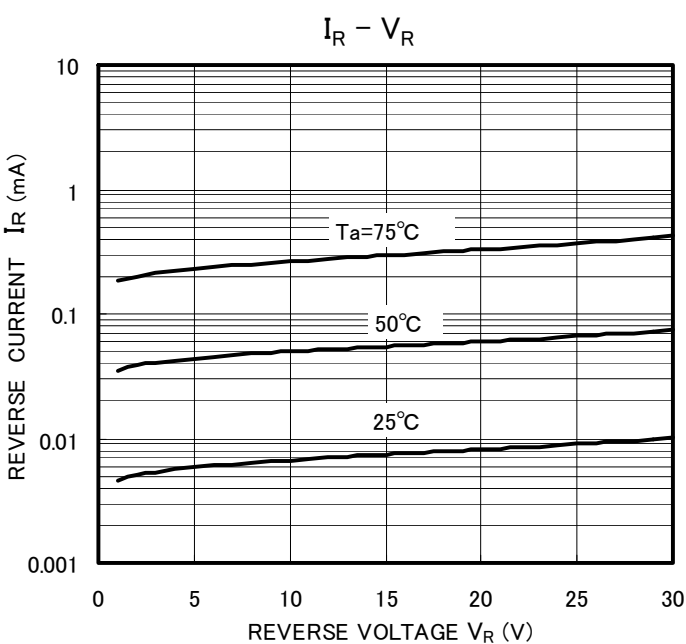
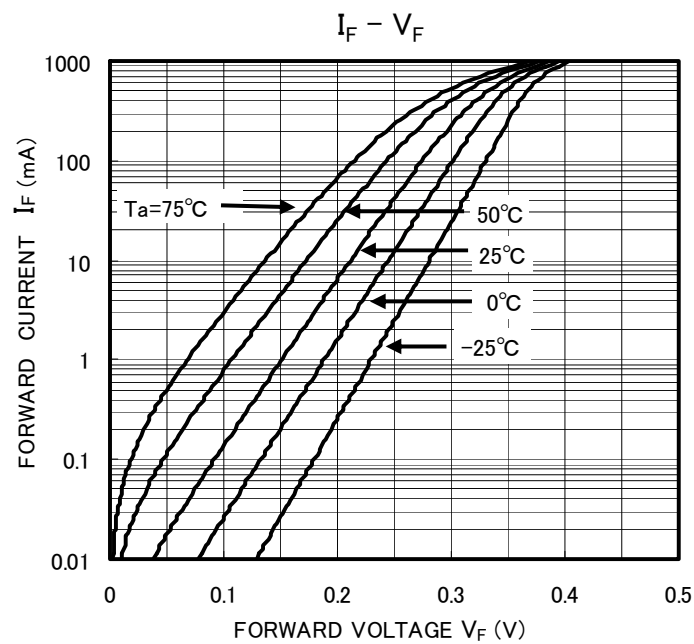


### Equivalent Circuit (top view)



### Handling Precaution

Schottky barrier diodes have reverse current characteristic compared to the other diodes. There is a possibility SBD may cause thermal runaway when it is used under high temperature or high voltage. Please take forward and reverse loss into consideration during design.



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